

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT5907281

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
L&T TECHNOLOGY SERVICES LIMITED	06/06/2018
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	MEDTRONIC ENGINEERING AND INNOVATION CENTER PRIVATE LIMITED
<b>Street Address:</b>	DLF CYBERSITY, BLOCK NO. 3
<b>Internal Address:</b>	GROUND FLOOR, PLOT NO. 129 TO 132 APHB COLONY, GACHIBOWLI, HYDERABAD
<b>City:</b>	ANDHRA PRADESH
<b>State/Country:</b>	INDIA
<b>Postal Code:</b>	500019
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15960964
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Email:</b>	rs.vasciption@medtronic.com
<b>Correspondent Name:</b>	MEDTRONIC VASCULAR, INC.
<b>Address Line 1:</b>	3576 UNOCAL PLACE
<b>Address Line 4:</b>	SANTA ROSA, CALIFORNIA 95403
<b>ATTORNEY DOCKET NUMBER:</b>	C00017632.USU1
<b>NAME OF SUBMITTER:</b>	THOMAS A. BEATON
<b>SIGNATURE:</b>	/Thomas A. Beaton/
<b>DATE SIGNED:</b>	01/13/2020
<b>Total Attachments: 4</b>	
source=L&T Assignment C00017632#page1.tif	
source=L&T Assignment C00017632#page2.tif	
source=L&T Assignment C00017632#page3.tif	
source=L&T Assignment C00017632#page4.tif	

## **DEED OF ASSIGNMENT**

This Deed of Assignment is executed by:

**L&T TECHNOLOGY SERVICES LIMITED**, having its registered office at L&T House, Ballard Estate, Mumbai 400001, India, and its representatives and affiliates (hereinafter referred to as "Assignor");

and, **MEDTRONIC ENGINEERING AND INNOVATION CENTER PRIVATE LIMITED**, having offices at DLF Cybercity, Block No. 3, Ground Floor, Plot No. 129 to 132 APHB Colony, Gachibowli, Hyderabad – 500019, Andhra Pradesh, India (hereinafter referred to as "Assignee").

WHEREAS, Assignor and Assignee entered into an Engineering Development Agreement dated October 17, 2011;

WHEREAS the Engineering Development Agreement transferred and assigned, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, all right, title and interest in any and all intellectual property, trade secrets and knowledge, including but not limited to methods, ideas, apparatuses, compositions, drawings, abstracts, specifications, inventions, written material, audiovisual material, formulas, data, computer software and rights related thereto, including but not limited to copyrights, trademarks, patents, patent applications, trade secrets, and other properties developed by Assignor or Assignee under the Engineering Development Agreement either jointly or individually ("Intellectual Property");

WHEREAS, Assignor hereby acknowledges, by virtue of the Engineering Development Agreement, Assignor transferred to Assignee all right, title and interest in and to the inventions and applications (including any continuations, continuations-in-part, divisionals, RCE's or other parent or child applications or inventions) and to all foreign counterparts thereof (including patent, utility model and industrial designs), as listed on the attached *Schedule A*, and in and to any Letters Patent and Registrations which may hereafter be granted on any patent applications claiming priority from the same in the United States and all countries throughout the world, and to claim the priority from the applications as provided by the Paris Convention. The right, title and interest is to be held and enjoyed by Assignee and Assignee's successors and assigns as fully and exclusively as it would have been held and enjoyed by Assignor had this Deed of Assignment not been made, for the full term of any Letters Patent and Registrations which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof;

WHEREAS Assignor desires to ensure to that to the extent any of Assignor's right, title and interest in the foregoing Intellectual Property, including the patents and applications listed on the attached *Schedule A*, are deemed not transferred from Assignor to Assignee, that any such past, present and future rights, title and interest in the foregoing Intellectual Property be presently assigned to Assignee.

[CONTINUED ON NEXT PAGE]

NOW, THEREFORE, the parties agree as follows:

ASSIGNOR: L&T TECHNOLOGY SERVICES LIMITED

Hereby sells, assigns and transfers to

ASSIGNEE: MEDTRONIC ENGINEERING AND INNOVATION CENTER PRIVATE LIMITED

And the successors, assigns and legal representatives of the ASSIGNEE any and all rights, title and interest ASSIGNOR may have, if any, including the right to sue for present, past and future infringement, in the United States, its territorial possessions, and in all foreign countries, including all treaty and convention rights, the Intellectual Property, including the inventions and applications (including any continuations, continuations-in-part, divisionals, RCE's or other parent or child applications or inventions) and to all foreign counterparts thereof (including patent, utility model and industrial designs), as listed on the attached *Schedule A*, and in and to any Letters Patent and Registrations which may hereafter be granted on any patent applications claiming priority from the same in the United States and all countries throughout the world, and to claim the priority from the applications as provided by the Paris Convention.

[THE REST OF THIS PAGE LEFT INTENTIONALLY BLANK]

IN TESTIMONY WHEREOF, Assignor has signed his name on the date indicated.

**L&T TECHNOLOGY SERVICES LIMITED**

**MEDTRONIC ENGINEERING AND  
INNOVATION CENTER PRIVATE  
LIMITED**



Printed Name: BHUPENDRA BHATE

Printed Name: DIVYA PRAKASH JOSHI

Title: COO

Title: SITE DIRECTOR, MEIC

Dated: 6<sup>th</sup> JUNE 2018

Dated: 04 Sep 2018

WITNESS



WITNESS



Printed Name: Ramesh S Rao

Printed Name: AMARSINH JADHAV.

Dated: 18 - June - 2018

Dated: 04 SEPT-2018

**SCHEDULE A**

**Patents and Patent Applications**

Docket Number	Application No. Filing Date	Application No.	Title
C00017632	15/960,964	April 24, 2018	<b>METHOD OF REPROCESSING A SURGICAL INSTRUMENT</b>